



04-02-2004

B/O FORM PTO-1595 (Rev. 4/00)



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RECORDATION
PATENT

102775194

To the Commissioner for Patents. Please record the attached original documents or copies thereof.

1. Name of Conveying Party(ies):

Kenji MATSUMOTO;
Eiji TOMITA;
Sadami YOSHIYAMA

Additional names of conveying parties attached.

2. Name and Address of Receiving Party(ies):

Name: **UCHIYAMA MANUFACTURING CORP.**

Internal Address:

Street Address: **338, Enami, Okayama-shi**

City, State, Zip: **Okayama, JAPAN**

Additional name(s) and address(es) attached.

3. Nature of Conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other:

Execution Date: 1/26/2004; 1/28/2004; 1/28/2004

4. (A) Patent Application Number(s):

10/704,375

4. (B) Patent Number(s):

If this document is being filed together with a new application, the execution date of the application is:

Additional Numbers Attached

5. Name and Address of Party to whom Correspondence Concerning this Document Should be Mailed:

Name: **Felix J. D'Ambrosio**
Address: **23364**
Customer Number
Phone: (703) 683-0500

Total Number of Applications and Patents Involved:

1

7. Total Fee: (37 CFR 3.41)

\$40.00

- Enclosed
- Authorized to be charged to deposit account

8. Deposit Account Number: **02-0200**

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9. Statement and Signature:

To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original document.

Felix J. D'Ambrosio

March 31, 2004

Name of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments and document:

04/02/2004 00000050 10704375

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40.00 EP

ASSIGNMENT

In consideration of One Dollar (\$1.00), and other good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned,

Kenji MATSUMOTO
Eiji TOMITA
Sadami YOSHIYAMA

Hereby sell, assign and transfer to **UCHIYAMA MANUFACTURING CORP.**, a corporation of **Japan**, having a place of business at **338, Enami, Okayama-shi, Okayama, Japan**, its successors, assigns and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, **Appln. No. 10/704,375**, filed on **November 10, 2003** and is entitled: **GASKET EMBEDDING AN ION SENSOR**, and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date.....1/26/2004.....

By.....Kenji Matsumoto.....(L.S.)
(Kenji MATSUMOTO)

Date.....1/28/2004.....

By.....Eiji Tomita.....(L.S.)
(Eiji TOMITA)

Date.....1/28/2004.....

By.....Sadami Yoshiyama.....(L.S.)
(Sadami YOSHIYAMA)